IPC ASSOCIATION ELECTRONIE	© Copyright 200:	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under international and Pan-American copyright conventions.			nder both le	This docume evel parts, th	nt is a declarat ne declaration e	on of the	substances ses all lower	within the materia	anufacturer als for whi	r listed iter ch the mar	n. Note: if nufacturer	the item is an as has engineering	sembly with low responsibility.
752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					s Material	s and Mfg	Informati	on	
Supplie	r Information						·								
Company name*				mpany unique ID			Unique ID Authority					Response Date*			
nsemi												2024-05-10			
Contact N	Name		Title - Conta	Title - Contact			Phone - Contact*					Email - Contact*			
Product-	Env-Stewards		Product Enviro Compliance			I	NA					Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*		Title - Representative			P	Phone - Representative*				Email - Representative*				
Product-	Env-Stewards		Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date Version Manufacturing		g Site	Weight*		UOM	Unit Type		
		NCP81566MNTXG 8+1 IMVP9.2 vC		8+1 IMVP9.2 v0.7	controller 2		2024-05-10	-05-10 TH6		ГН6		11	1.17	mg	Each
Ianufa	ncturing Process Inform														
	8		,		-STD-020 MSL	Rating			s Body Temperature Max Time at Peak		at Peak T	1		er of Reflow Cyc	eles
	Matte Tin (Sn) - annealed	(CU Alloy	1			260		C	30		seconds	3		
omments															
	naximum time at peak temper														
or more	information regarding mater	ial composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a						
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	9.84	mg	Supplier	Silicon (Si)	7440-21-3		9.84	mg
Die Attach	3.02	mg		Epoxy resin	proprietary data		0.6946	mg
			Supplier	Silver (Ag)	7440-22-4		2.3254	mg
Lead Frame	52.8	mg	Supplier	Silver (Ag)	7440-22-4		0.4224	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0528	mg
			Supplier	Iron (Fe)	7439-89-6		1.3728	mg
			Supplier	Copper (Cu)	7440-50-8		50.952	mg
Mold Compound-Black	42.74	mg		Epoxy resin	proprietary data		2.137	mg
			Supplier	Phenolic Resin	Proprietary Data		0.983	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.137	mg
			Supplier	Carbon Black (C)	1333-86-4		0.171	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.983	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		36.329	mg
Plating	2.63	mg	Supplier	Tin (Sn)	7440-31-5		2.63	mg
Wire Bond - Cu	0.14	mg	Supplier	Palladium (Pd)	7440-05-3		0.0025	mg
			Supplier	Gold (Au)	7440-57-5		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.1373	mg